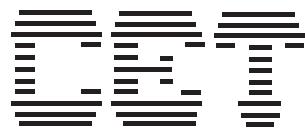


BSS84



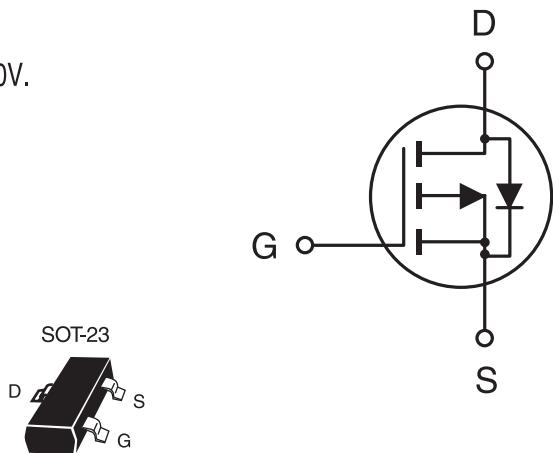
PRELIMINARY

P-Channel Enhancement Mode MOSFET

FEATURES

7

- -50V , -0.13A , $R_{DS(ON)}=10\Omega$ @ $V_{GS}=-10V$.
- High dense cell design for low $R_{DS(ON)}$.
- Rugged and reliable.
- Surface Mount Package.



ABSOLUTE MAXIMUM RATINGS ($T_A=25^\circ C$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	-50	V
Gate-Source Voltage	V_{GS}	± 20	V
Drain Current-Continuous ^a @ $T_J=125^\circ C$ -Pulsed ^b	I_D	-0.13	A
	I_{DM}	-0.52	A
Drain-Source Diode Forward Current ^a	I_S	-0.13	A
Maximum Power Dissipation ^a	P_D	0.36	W
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150	$^\circ C$

THERMAL CHARACTERISTICS

Thermal Resistance, Junction-to-Ambient ^a	$R_{\theta JA}$	350	$^\circ C/W$
------------------------------------------------------	-----------------	-----	--------------

BSS84

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ C$ unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	V_{DSS}	$V_{GS} = 0V, I_D = -250\mu A$	-50			V
Zero Gate Voltage Drain Current	$I_{DS(on)}$	$V_{DS} = -50V, V_{GS} = 0V$			-15	μA
Gate-Body Leakage	I_{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$			± 10	nA
ON CHARACTERISTICS^b						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -1mA$	-0.8	-1.75	-2	V
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS} = -10V, I_D = -0.13A$		2.3	10	Ω
Forward Transconductance	g_{FS}	$V_{DS} = -10V, I_D = -0.13A$	0.05	0.27		S
DYNAMIC CHARACTERISTICS^c						
Input Capacitance	C_{iss}	$V_{DS} = -25V, V_{GS} = 0V$ $f = 1.0MHz$		37	45	pF
Output Capacitance	C_{oss}			16	25	pF
Reverse Transfer Capacitance	C_{rss}			5	12	pF
SWITCHING CHARACTERISTICS^c						
Turn-On Delay Time	$t_{D(ON)}$	$V_{DD} = -30V,$ $I_D = -0.27A,$ $V_{GS} = -10V,$ $R_{GEN} = 50\Omega$		9	12	ns
Rise Time	t_r			38	50	ns
Turn-Off Delay Time	$t_{D(OFF)}$			8	10	ns
Fall Time	t_f			19	25	ns

BSS84

ELECTRICAL CHARACTERISTICS ($T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ ^c	Max	Unit
DRAIN-SOURCE DIODE CHARACTERISTICS^b						
Diode Forward Voltage	V_{SD}	$V_{GS} = 0V, I_S = -0.26A$		-0.95	-1.2	V

Notes

7

- a. Surface Mounted on FR4 Board, $t \leq 10\text{sec}$.
- b. Pulse Test: Pulse Width $\leq 300 \mu\text{s}$, Duty Cycle $\leq 2\%$.
- c. Guaranteed by design, not subject to production testing.

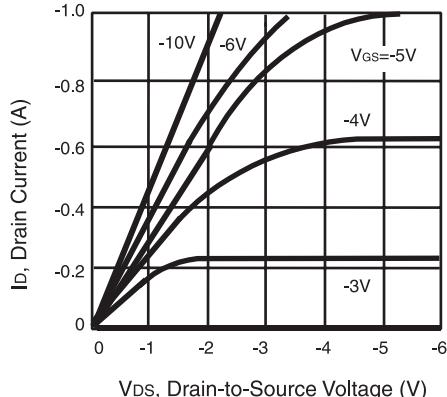


Figure 1. Output Characteristics

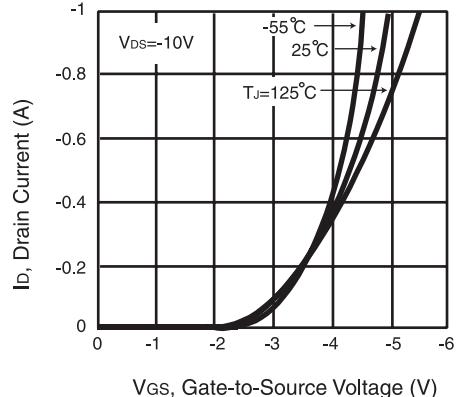


Figure 2. Transfer Characteristics

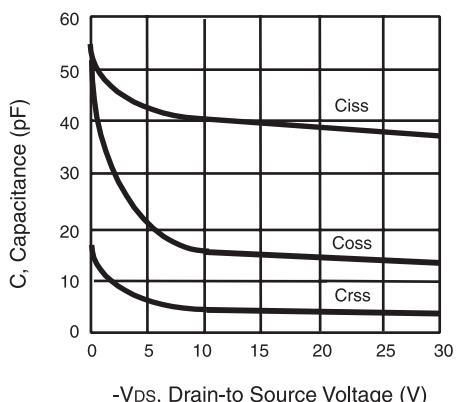


Figure 3. Capacitance

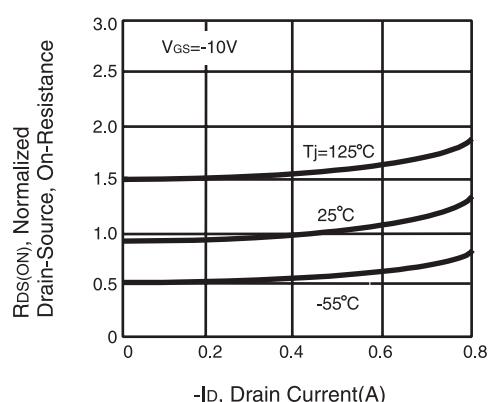


Figure 4. On-Resistance Variation with Drain Current and Temperature

BSS84

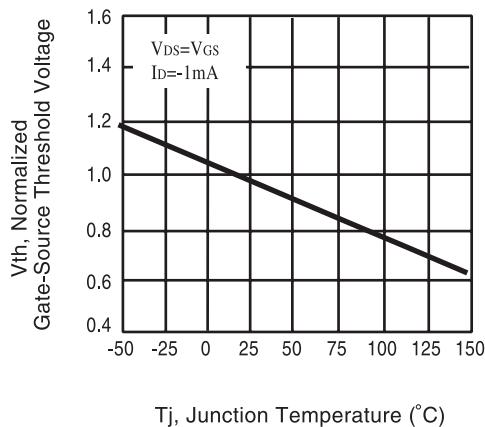


Figure 5. Gate Threshold Variation with Temperature

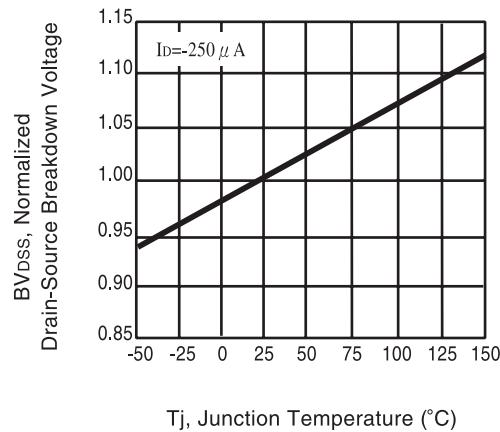


Figure 6. Breakdown Voltage Variation with Temperature

7

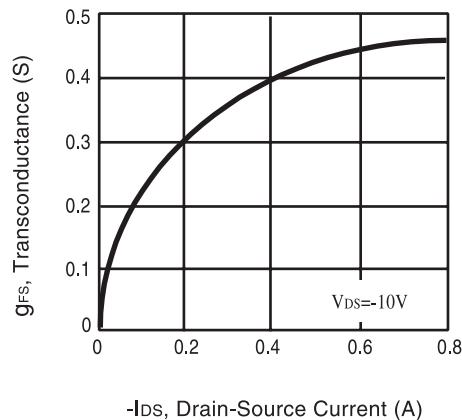


Figure 7. Transconductance Variation with Drain Current

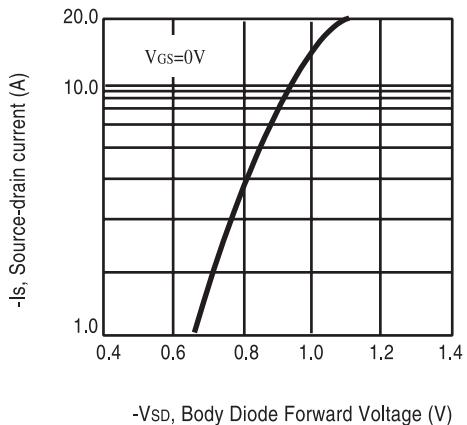


Figure 8. Body Diode Forward Voltage Variation with Source Current

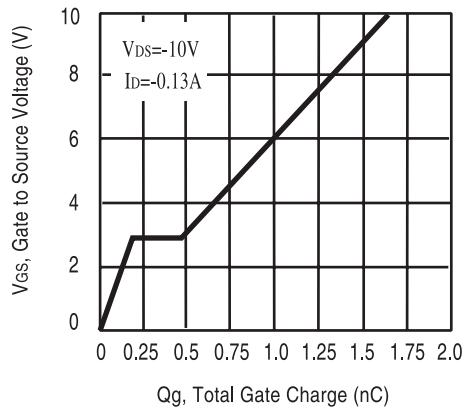


Figure 9. Gate Charge

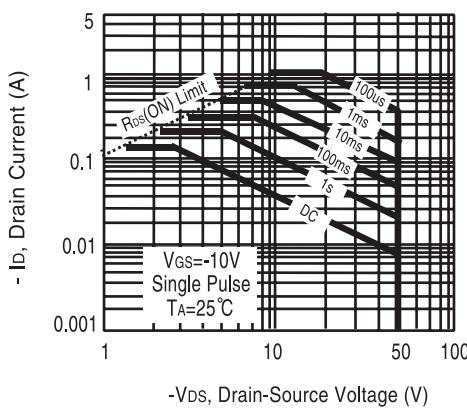


Figure 10. Maximum Safe Operating Area

BSS84

7

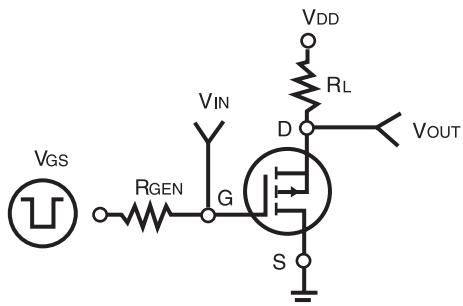


Figure 11. Switching Test Circuit

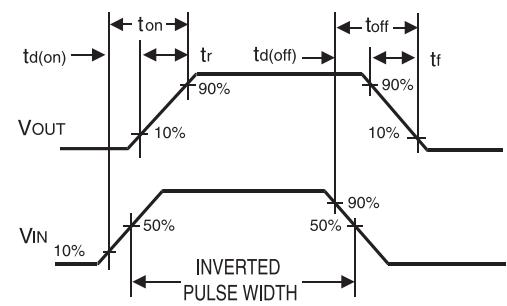


Figure 12. Switching Waveforms

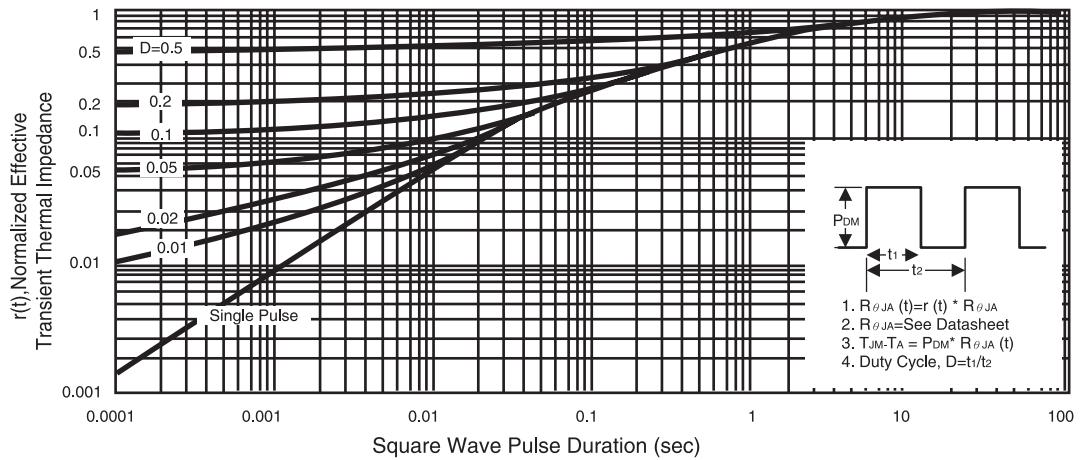


Figure 13. Normalized Thermal Transient Impedance Curve